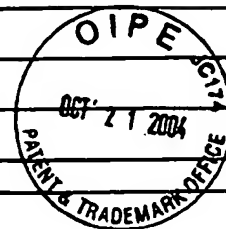


INFORMATION DISCLOSURE CITATION

Atty. Docket No. 2887.0274	Appln. No. 10/815,934
Applicant Takyu et al.	
Filing Date April 2, 2004	Group: 2812 2823



U.S. PATENT DOCUMENTS						
Examiner Initial*	Document Number	Issue Date	Name	Class	Sub Class	Filing Date If Appropriate
BK	2003/0060034 A1	3/27/03	Beyne et al.			
BK	2003/0060021 A1	3/27/03	Kurosawa et al.			
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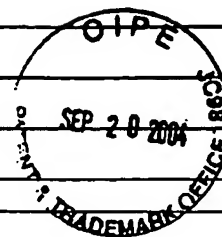
FOREIGN PATENT DOCUMENTS						
	Document Number	Publication Date	Country	Class	Sub Class	Translation Yes or No
	0 981 156 A2	2/23/00	Europe			

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)	
	European Search Report in Application No. 04008108, dated 8/5/04

Examiner <i>Brook Kebede</i>	Date Considered <i>2/19/2005</i>
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Atty. Docket No. 2887.0274	Appln. No. 10/815,934
Applicant Takyu et al.	
Filing Date April 2, 2004	Group: 2812J823



U.S. PATENT DOCUMENTS							
Examiner Initial*		Document Number	Issue Date	Name	Class	Sub Class	Filing Date If Appropriate

FOREIGN PATENT DOCUMENTS							
		Document Number	Publication Date	Country	Class	Sub Class	Translation Yes or No
Bu		2003-017513	1/17/03	Japan			Abstract

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)	

Examiner Brown Kebede	Date Considered 2/19/2005
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INFORMATION DISCLOSURE CITATION

Atty. Docket No. 02887.0274	Application No. 10/815,934
Applicant Shinya TAKYU et al.	
Filing Date April 2, 2004	Group: 2823 Not assigned

U.S. PATENT DOCUMENTS						
Examiner Initial*	Document Number	Issue Date	Name	Class	Sub Class	Filing Date If Appropriate
BU	4,778,326	10/18/88	Althouse et al.			
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	Document Number	Publication Date	Country	Class	Sub Class	Translation Yes or No
BU	2000-091281	3/31/00	Japan			Abstract
BU	2000-315697	11/14/00	Japan			Abstract
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K						

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)	
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Examiner Brook Kebede	Date Considered 2/19/2005
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